



88Vac-132Vac (by shorting J2) or 184Vac-275Vac
5 amp max

30V @ 6.5A Cont.
10A Peak

Assembly Notes:
Ref. Des. > 99 were added on the board
Built on PMP2573 Rev_B PWB



Title Low and High Line to 30V @ 200W nom, 300W peak		
Size C	Number PMP8518	Rev A
Date 10/18/2011	Drawn by R. Scibilia	
Engineer R. Scibilia	Filename PMP8518 Rev_A_pads.sch	Sheet 1 of 1

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